

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN#20230217003.1 Qualify TI Mexico as an additional Assembly site for select devices Change Notification / Sample Request

Date: February 17, 2023 **To:** PREMIER FARNELL PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (PCN www admin team@list.ti.com). For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

PCN Team SC Business Services

20230217003.1 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE TPS54335ADDA

CUSTOMER PART NUMBER

null

Technical details of this Product Change follow on the next page(s).

PCN Number:			20230217003.1					P	CI	N Date: February 17, 2023			
Title: Qualify TI Mexico as an additional Assembly							site for sel	lec	t c	devices			
Customer Contact: PCN M			PCN Manager			Dept:	Quality Services						
Proposed 1 st Ship Date:				May 17, 2023			Sample requests accepted until:			Mar 17, 2023*			
*Sample requests received after Mar						17, 20	23 will not	be suppor	te	d.			
Change Type:													
X	Assembly Site					Design					Wafer Bump Site		
Assembly Process					Data Sheet					Wafer Bump Material			
\boxtimes	Asse	mbly Material	S			Part number change				Wafer Bump Process			
Mechanical Specification			ntion		Test Site				Wafer Fab Site				
□ Packing/Shipping/Labeling			beling		Test Process			Wafer Fal	fer Fab Materials				
											Wafer Fal	Process	
	PCN Details												
Des	Description of Change:												

Texas Instruments is pleased to announce the qualification of TI Mexico as an additional Assembly site for the list of devices shown below. Material differences between sites as follows.

Assembly Site	Assembly Site Origin	Assembly Country Code	Assembly City
ASESH	ASH	CHN	Shanghai
TI Mexico	MEX	MEX	Aguascalientes

Material Differences:

	ASESH	TI Mexico		
Mount compound	EY1000063	4147858		
Mold Compound	EN2000509, EN20000519	4211880		

Package Marking differences:

e Marking differences:							
	ASESH	TI Mexico					
Pin One ID	Stripe	Dimple					
ECAT value	With	Without					
Example	33610A TI YMS PLLLG4 TI = TI LETTERS YM = YEAR MONTH DATE CODE LLL = ASSEMBLY LOT CODE S = ASSEMBLY SITE CODE P = SECONDARY SITE CODE G4 = ECAT ■ = PIN 1 STRIPE	33610A TI YMS LLLL O TI = TI LETTERS YM = YEAR MONTH DATE CODE LLLL = ASSEMBLY LOT CODE S = ASSEMBLY SITE CODE O = PIN 1 INDICATOR					

Reason for Change:

Continuity of Supply

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

Impact on Environmental Ratings:

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
No Change	⊠ No Change	⊠ No Change	No Change

Changes to product identification resulting from this PCN:

Assembly Site						
ASESH	Assembly Site Origin (22L)	ASO: ASH				
TI Mexico	Assembly Site Origin (22L)	ASO: MEX				

Sample product shipping label (not actual product label)



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(1P) \$N74L\$07N\$R (a) 2000 (D) 0336 (31T) LOT: 3959047MLA (4W) TKY(1T) 7523483812

PT: 1750 LBL: 5A (L)T0:1750 (P) (P) (V) 0033317 (20L) CSO: SHE (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

Product Affected

LMR33610ADDAR	TPS54327DDAR	TPS54335ADDAR	LMR33620CDDA
LMR33610BDDAR	TPS54328DDA	TPS54336ADDA	LMR33620CDDAR
LMR33620BDDAR	TPS54328DDAR	TPS54336ADDAR	LMR33630ADDA
LMR33630BDDAR	TPS54329DDA	TPS54531DDA	LMR33630ADDAR
LMR33640ADDAR	TPS54329DDAR	TPS54531DDAR	LMR33630BDDA
SN1101003DDAR	TPS54329EDDA	LMR33620ADDA	LMR33630CDDA
SN1708001DDAR	TPS54329EDDAR	LMR33620ADDAR	LMR33630CDDAR
TPS54327DDA	TPS54335ADDA	LMR33620BDDA	LMR33640DDDAR

Qualification Report

Approve Date 19-Jan-2023

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: LMR33610ADDAR	Qual Device: IPS54335ADDAR	Qual Device: TPS54531DDAR	QBS Reference: LMR16020PDDAR	QBS Reference: DRV8251DDAR	QBS Reference: LM5169FQDDARQ1
HAST	A2	Biased HAST	110C/85%RH	264 Hours	-	-		-	-	3/231/0
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	-	-	3/231/0	
UHAST	А3	Autoclave	121C/15psig	96 Hours	3/231/0	-	-	3/231/0	3/231/0	-
UHAST	А3	Unbiased HAST	110C/85%RH	264 Hours	-	-	-	-	-	3/231/0
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	3/231/0	1/77/0	-	3/231/0	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours		-		3/231/0	3/231/0	-
HTSL	A6	High Temperature Storage Life	175C	500 Hours					-	3/135/0
HTOL	B1	Life Test	125C	1000 Hours	-	-	-	-	1/77/0	-
HTOL	B1	Life Test	150C	300 Hours	-	-	-	-	-	1/77/0
WBS	C1	Ball Shear	76 balls, 3 units min	Wires	3/228/0	1/76/0	1/76/0	3/228/0	3/228/0	3/90/0
WBP	C2	Bond Pull	76 Wires, 3 units min	Wires	3/228/0	1/76/0	1/76/0	3/228/0	3/228/0	3/90/0
SD	C3	PB Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes); PB Solder;	-	-	-	-	-	3/66/0	
SD	СЗ	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	-		-	3/66/0	1/15/0
PD	C4	Physical Dimensions	Cpk>1.67	-	3/30/0	1/10/0	1/10/0	3/30/0	3/30/0	3/30/0
ESD	E2	ESD CDM		1500 Volts	-	-	-	-	1/3/0	
ESD	E2	ESD CDM		500 Volts	-	-	-	-	-	1/3/0
ESD	E2	ESD HBM	-	2000 Volts	-	-	-	-	-	1/3/0
ESD	E2	ESD HBM	-	4000 Volts	-	-	-	-	1/3/0	-
LU	E4	Latch-Up	Per JESD78	-	-	-		-	1/6/0	1/6/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	-	1/30/0	1/30/0	1/30/0	3/90/0	
CHAR	E5	Electrical Distributions	Cpk>1.67 Room, hot, and cold	-			-	•	-	3/90/0

QBS: Qual By Similarity

Qual Device LMR33610ADDAR is qualified at MSL2 260C

Qual Device TPS54335ADDAR is qualified at MSL2 260C

Qual Device TPS54531DDAR is qualified at MSL2 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV:125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV:150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/ Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN www admin_team@list.ti.com

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